IPC ASSOCIATION CONNECTION ELECTRONICS INDUSTRIE	© Copyright 2005. IPC,	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.		der both This docum level parts,	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.								
752-21.1	IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				Form Type * Distribute	* Declaration Class * Class 6 - RoHS Yes/No. Homogeneous Materi				ials and Mfg Information			
upplier Inforn	nation												
Company name*			Company unique ID			Unique ID Authority				Response Date*			
onsemi										2025-06-04			
Contact Name			Title - Contact			Phone - Contact*				Email - Contact*			
Product-Env-Stewards			Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com			
Authorized Representative*			Title - Representative			Phone - Representative*			Email - Representative*				
Product-Env-Stewards			Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com			
Request	er Item Number	NCP1399ANDR2G High Perf Cu		Mfr Item Name		Effective Da	nte Versio	n l	Manufacturing Site	W	/eight*	UOM	Unit Type
				High Perf Current N with Integrated HV	Mode Resonant Controller Drivers	ler 2025-06-04 PH1		PH1	1	79.58	mg	Each	
Ianufacturing	Process Information	n											
Terminal Plating / Grid Array Material Te		erminal Base Alloy J-STD-020 MSL		STD-020 MSL Rating	Peak Process Body Temperature		re Max Time at Peak	Temperatu	re Numbe	er of Reflow Cyc	les		
Matte Tin (Sn) - annealed		\mathbf{C}	CU Alloy 3			260 C 30		second	s 3				
omments													
TTENTION: MS	L 3 Rated item requires Ba	ake and Di	ry Pack (after	electrical test)									
or more informat	ion regarding material con	position p	olease refer to	page 3									

RoHS Material Composition Declaration			Declaration Type *	Detail	led						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier have provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substa	ances per the definition above	Supplier Ac	ceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructional Complete all of the required	fields on all neggs of this form. Calcut th		a duan dawn. This will display the signature on	a Digitally sign	the declaration (if recruired by the						
Instructions: Complete all of the required Requester) and click on Submit Form to			e drop-down. This will display the signature ar	ea. Digitally sign	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	5.37	mg	Supplier	Silicon (Si)	7440-21-3		5.37	mg
Die Attach	0.58	mg		Proprietary	proprietary data		0.058	mg
			Supplier	Aluminum Trioxide (Al2O3)	1344-28-1		0.464	mg
			Supplier	Formaldehyde Polymer	9003-36-5		0.058	mg
Lead Frame	70.13	mg	Supplier	Silver (Ag)	7440-22-4		0.561	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0842	mg
			Supplier	Iron (Fe)	7439-89-6		1.6481	mg
			Supplier	Copper (Cu)	7440-50-8		67.8157	mg
			Supplier	Phosphorus (P)	7723-14-0		0.021	mg
Mold Compound-Black	101.52	mg		Epoxy resin	proprietary data		5.076	mg
			Supplier	Phenolic Resin	Proprietary Data		2.0304	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		2.538	mg
			Supplier	Carbon Black (C)	1333-86-4		0.5076	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		91.368	mg
Plating	1.87	mg	Supplier	Tin (Sn)	7440-31-5		1.87	mg
Wire Bond	0.11	mg	Supplier	Palladium (Pd)	7440-05-3		0.0023	mg
			Supplier	Gold (Au)	7440-57-5		0.0003	mg
			Supplier	Copper (Cu)	7440-50-8		0.1074	mg